Rev. 2.0, 21.02.2019

# LED430-66-60

- Blue High Power LED Array
- 430 nm, 690 mW
- Chip: 350x350 μm, 60 pcs., InGaN
- TO-66 Package, Silicone and/or Epoxy Resin
- Viewing Angle: 122°





## Description

**LED430-66-60** is a wide viewing and extremely high output power illuminator containing an array of 60 pcs. InGaN chip dies, mounted on a metal stem TO-66 and covered with a silicone and/or epoxy resin. On forward bias a power radiation of typical 690 mW is given at a peak wavelength of 430 nm.

## Maximum Ratings (TCASE=25°C)

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Parameter	Symbol	Min.	Max.	Unit		
Power Dissipation	PD		12	W		
Forward Current	l <sub>F</sub>		600	mA		
Reverse Voltage	VF		25	V		
Thermal Resistance	RTHJA		2	K/W		
Junction Temperature	TJ		120	°C		
Operating Temperature	TCASE	- 40	+ 85	°C		
Storage Temperature	$T_{STG}$	- 40	+ 100	°C		
Lead Solder Temperature *	T <sub>SLD</sub>		+ 265	°C		

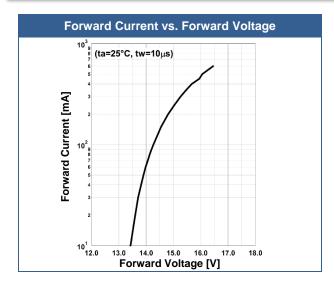
<sup>\*</sup> must be completed within 3 seconds

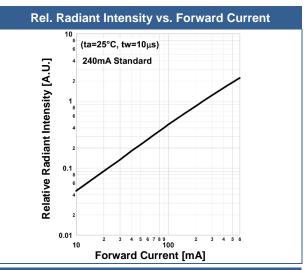
## Electro-Optical Characteristics (TCASE=25°C)

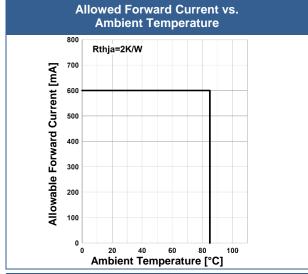
Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	$\lambda_P$	I <sub>F</sub> =240mA	420		440	nm
Half Width	$\Delta \lambda$	I <sub>F</sub> =240mA		16		nm
Forward Voltage	VF	I <sub>F</sub> =240mA		15	20	V
Radiated Power *	Po	I <sub>F</sub> =240mA		690		mW
Luminous Flux	$oldsymbol{\phi}_V$	I <sub>F</sub> =240mA		14		lm
Viewing Angle	φ	I <sub>F</sub> =100mA		122		deg.
Rise Time	<b>t</b> r	I <sub>F</sub> =240mA		20		ns
Fall Time	<b>t</b> f	I <sub>F</sub> =240mA		20		ns

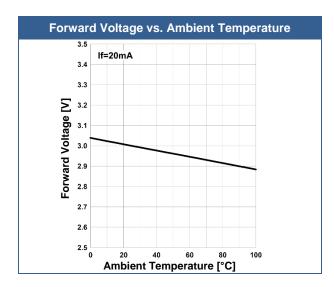
<sup>\*</sup> measured by \$3584-08

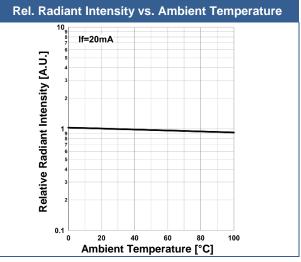
## **Typical Performance Curves**









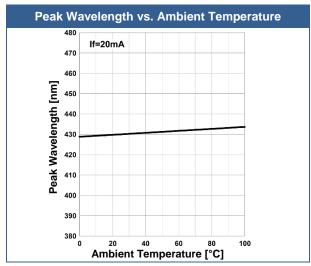


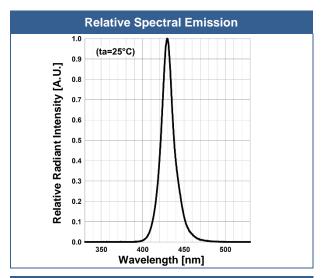


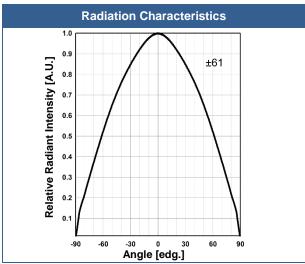
# ROITHNER LASERTECHNIK GmbH

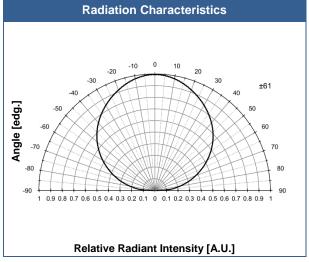
WIEDNER HAUPTSTRASSE 76 IO40 VIENNA AUSTRIA TEL. +43 I 586 52 43 -0, FAX. -44 OFFICE@ROITHNER-LASER.COM



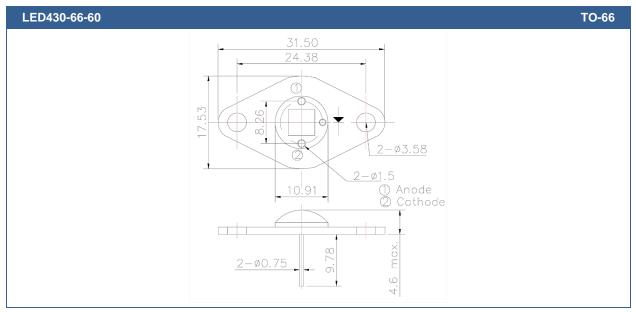








## **Outline Dimensions**



All Dimensions in mm

#### **Precautions**

#### Cautions:

- This high power LED must be cooled!
- NOT look directly into the emitting area of the LED during operation!

#### Soldering:

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- · Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

#### Cleaning:

Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended

DO NOT USE acetone, chloroseen, trichloroethylene, or MKS

DO NOT USE ultrasonic cleaners

#### Static Electricity:

**LEDs are sensitive to electrostatic discharge (ESD)**. Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

#### Radiation:

During operation these LEDs do emit **high intensity light**, which is hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light. **Protective glasses are recommended**. It is further advised to attach a warning label on products/systems.

#### Operation:

#### Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device. Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

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